

NCE N-Channel Super Trench II Power MOSFET

Description

The series of devices uses **Super Trench II** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of $R_{\text{DS(ON)}}$ and Q_g . This device is ideal for high-frequency switching and synchronous rectification.

Application

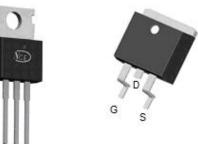
- DC/DC Converter
- ●Ideal for high-frequency switching and synchronous rectification

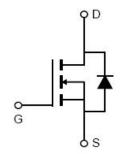
General Features

- V_{DS} =120V, I_D =130A $R_{DS(ON)}$ =4.5m Ω , typical (TO-220)@ V_{GS} =10V $R_{DS(ON)}$ =4.3m Ω , typical (TO-263)@ V_{GS} =10V
- Excellent gate charge x R_{DS(on)} product(FOM)
- Very low on-resistance R_{DS(on)}
- 175 °C operating temperature
- Pb-free lead plating

100% UIS TESTED! 100% ΔVds TESTED!







Schematic Diagram

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCEP050N12	NCEP050N12	TO-220	-	-	-
NCEP050N12D	NCEP050N12D	TO-263	-	-	-

Absolute Maximum Ratings (T_C=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	VDS	120	V
Gate-Source Voltage	Vgs	±20	V
Drain Current-Continuous	I _D	130	Α
Drain Current-Continuous(T _C =100°C)	I _D (100℃)	93	Α
Pulsed Drain Current	I _{DM}	520	Α
Maximum Power Dissipation	P _D	220	W
Derating factor		1.47	W/℃
Single pulse avalanche energy (Note 1)	Eas	1050	mJ
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	$^{\circ}$ C



NCEP050N12, NCEP050N12D

Thermal Characteristic

Thermal Resistance, Junction-to-Case	Rejc	0.68	°C/W	
memai resistance, ounction to ouse	1 1000	0.00	U C/ V V	П

Electrical Characteristics (T_C=25°C unless otherwise noted)

Parameter	Parameter Symbol Condition		Min	Тур	Max	Unit	
Off Characteristics				'			'
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =28	50μA	120		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =120V,V _G	s=0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V _{GS} =±20V,V _D	s=0V	-	-	±100	nA
On Characteristics							
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS},I_{D}=2$	50µA	2.0	3.0	4.0	V
	_	.,	TO-220	-	4.5	5.0	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =10V, I _D =65A	TO-263		4.3	5.0	mΩ
Forward Transconductance	g FS	V _{DS} =5V,I _D =6	65A	85	-	-	S
Dynamic Characteristics							
Input Capacitance	C _{lss}	V _{DS} =60V,V _{GS} =0V, F=1.0MHz		-	6880	-	PF
Output Capacitance	Coss			-	450	-	PF
Reverse Transfer Capacitance	C _{rss}			-	22	-	PF
Switching Characteristics (Note 2)							
Turn-on Delay Time	t _{d(on)}			-	20	-	nS
Turn-on Rise Time	t _r	$V_{DD}=60V,I_{D}=$	V_{DD} =60V, I_{D} =65A V_{GS} =10V, R_{G} =1.6 Ω		11.5	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{G} =			48	-	nS
Turn-Off Fall Time	t _f			-	10	-	nS
Total Gate Charge	Qg	.,	054	-	112	-	nC
Gate-Source Charge	Qgs	$V_{DS}=60V,I_{D}=$	·	-	36		nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V		-	27		nC
Drain-Source Diode Characteristics				1			
Diode Forward Voltage	V _{SD}	V _{GS} =0V,I _S =6	65A	-		1.2	V
Diode Forward Current	Is			-	-	130	Α
Reverse Recovery Time	t _{rr}	$T_J = 25^{\circ}C, I_F = I_S$ di/dt = 100A/ μ s		-	76	-	nS
Reverse Recovery Charge	Qrr			_	150		nC

Notes:

^{1.} EAS condition : Tj=25 $^{\circ}\mathrm{C}$,V_DD=50V,V_G=10V,L=0.5mH,Rg=25 Ω

^{2.} Guaranteed by design, not subject to production

^{3.} These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsin k, assuming a maximum junction temperature of TJ(MAX)=175° C. The SOA curve provides a single pulse rating.



Typical Electrical and Thermal Characteristics

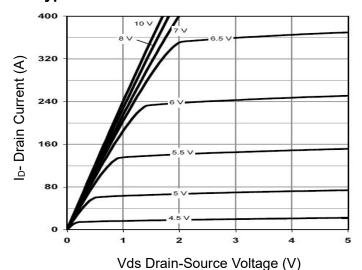
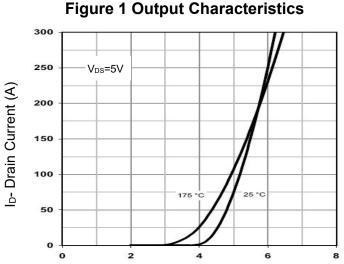
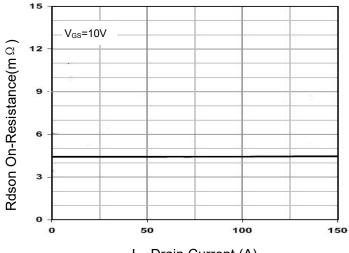


Figure 4 Output Characteristics

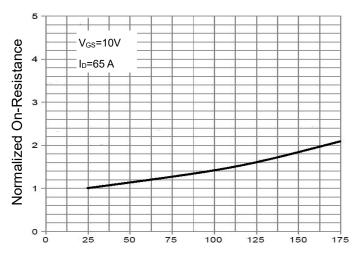


Vgs Gate-Source Voltage (V)
Figure 2 Transfer Characteristics



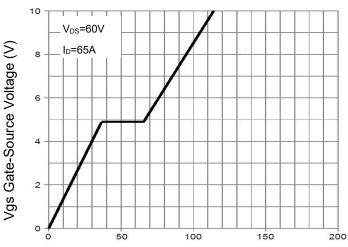
I_D- Drain Current (A)

Figure 3 Rdson- Drain Current



T_J-Junction Temperature(°C)

Figure 4 Rdson-Junction Temperature



Qg Gate Charge (nC)
Figure 5 Gate Charge

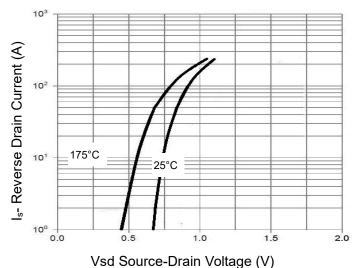


Figure 6 Source- Drain Diode Forward



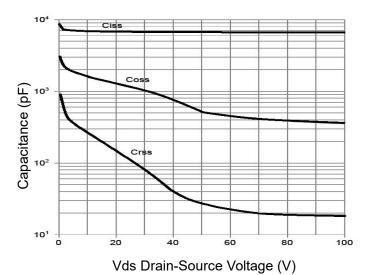


Figure 7 Capacitance vs Vds

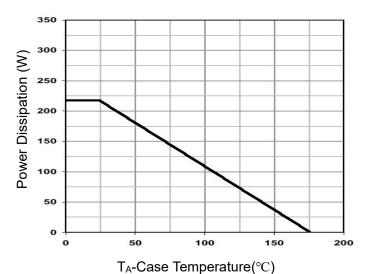


Figure 9 Power De-rating

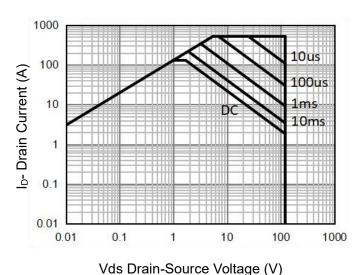


Figure 8 Safe Operation Area(Note 3)

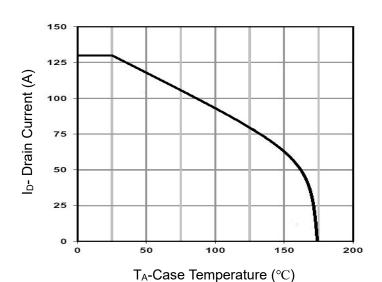
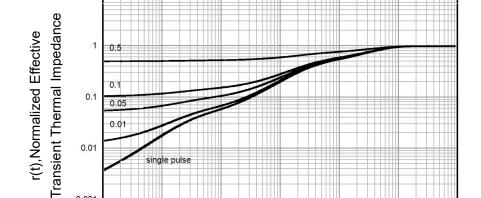


Figure 10 Current De-rating



0.00001

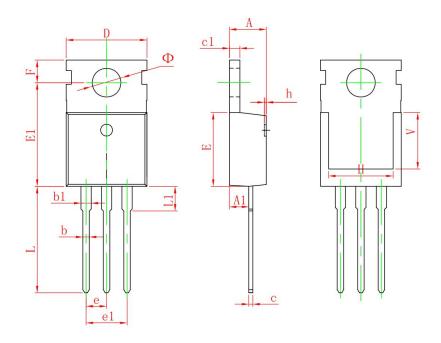
0.000001

on 0.0001 0.001 0.01 0. Square Wave Pluse Duration(sec)

Figure 11 Normalized Maximum Transient Thermal Impedance



TO-220-3L Package Information

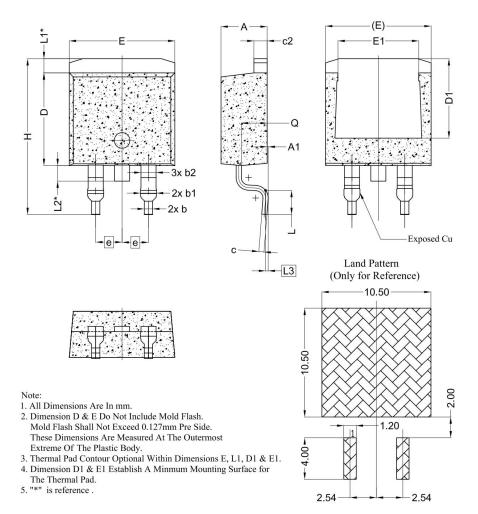


Symbol	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
E	8.950	9.750	0.352	0.384	
E1	12.650	13.050	0.498	0.514	
е	2.540	TYP.	0.100 TYP.		
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	6.900 REF.		0.276	REF.	
Φ	3.400	3.800	0.134	0.150	

http://www.ncepower.com



TO-263-2L Package Information



SYMBOL	DIMENSIONS				
STMBOL	MIN.	NOM.	MAX.		
Α	4.24	4.44	4.64		
A1	0.00	0.10	0.25		
b	0.70	0.80	0.90		
b1	1.20	1.55	1.75		
b2	1.20	1.45	1.70		
С	0.40	0.50	0.60		
c2	1.15	1.27	1.40		
D D1 E	8.82	8.92	9.02		
	6.86	7.65	_		
	9.96	10.16	10.36		
E1	6.89 7.77		7.89		
е	2.54 BSC				
Н	14.61	15.00	15.88		
L	1.78	2.32	2.79		
L1	1.36 REF.				
L2	1.50 REF.				
L3	0.25 BSC				
Q	2.30	2.48	2.70		

新功率 CEPOWER

NCEP050N12, NCEP050N12D

Attention:

- Any and all NCE power products described or contained herein do not have specifications that can handle applications that require extremely high levels of reliability, such as life-support systems, aircraft's control systems, or other applications whose failure can be reasonably expected to result in serious physical and/or material damage. Consult with your NCE power representative nearest you before using any NCE power products described or contained herein in such applications.
- NCE power assumes no responsibility for equipment failures that result from using products at values that exceed, even momentarily, rated values (such as maximum ratings, operating condition ranges, or other parameters) listed in products specifications of any and all NCE power products described or contained herein.
- Specifications of any and all NCE power products described or contained herein stipulate the performance, characteristics, and functions of the described products in the independent state, and are not guarantees of the performance, characteristics, and functions of the described products as mounted in the customer's products or equipment. To verify symptoms and states that cannot be evaluated in an independent device, the customer should always evaluate and test devices mounted in the customer's products or equipment.
- NCE power Semiconductor CO.,LTD. strives to supply high-quality high-reliability products. However, any and all semiconductor products fail with some probability. It is possible that these probabilistic failures could give rise to accidents or events that could endanger human lives, that could give rise to smoke or fire, or that could cause damage to other property. When designing equipment, adopt safety measures so that these kinds of accidents or events cannot occur. Such measures include but are not limited to protective circuits and error prevention circuits for safe design, redundant design, and structural design.
- In the event that any or all NCE power products(including technical data, services) described or contained herein are controlled under any of applicable local export control laws and regulations, such products must not be exported without obtaining the export license from the authorities concerned in accordance with the above law.
- No part of this publication may be reproduced or transmitted in any form or by any means, electronic or mechanical, including photocopying and recording, or any information storage or retrieval system, or otherwise, without the prior written permission of NCE power Semiconductor CO.,LTD.
- Information (including circuit diagrams and circuit parameters) herein is for example only; it is not guaranteed for volume production. NCE power believes information herein is accurate and reliable, but no guarantees are made or implied regarding its use or any infringements of intellectual property rights or other rights of third parties.
- Any and all information described or contained herein are subject to change without notice due to product/technology improvement, etc. When designing equipment, refer to the "Delivery Specification" for the NCE power product that you intend to use.
- This catalog provides information as of Sep.2010. Specifications and information herein are subject to change without notice.

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for MOSFET category:

Click to view products by NCE Power manufacturer:

Other Similar products are found below:

IRFD120 JANTX2N5237 2SK2267(Q) BUK455-60A/B TK100A10N1,S4X(S MIC4420CM-TR VN1206L NDP4060 SI4482DY
IRS2092STRPBF-EL IPS70R2K0CEAKMA1 TK31J60W5,S1VQ(O TK31J60W,S1VQ(O TK16J60W,S1VQ(O 2SK2614(TE16L1,Q)
DMN1017UCP3-7 EFC2J004NUZTDG P85W28HP2F-7071 DMN1053UCP4-7 NTE2384 DMC2700UDMQ-7 DMN2080UCB4-7
DMN61D9UWQ-13 US6M2GTR DMN31D5UDJ-7 DMP22D4UFO-7B IPS60R3K4CEAKMA1 DMN1006UCA6-7 DMN16M9UCA6-7
STF5N65M6 IRF40H233XTMA1 STU5N65M6 DMN6022SSD-13 DMN13M9UCA6-7 DMTH10H4M6SPS-13 IPS60R360PFD7SAKMA1
DMN2990UFB-7B SSM3K35CT,L3F IPLK60R1K0PFD7ATMA1 2N7002W-G MCAC30N06Y-TP IPWS65R035CFD7AXKSA1
MCQ7328-TP SSM3J143TU,LXHF DMN12M3UCA6-7 PJMF280N65E1_T0_00201 PJMF380N65E1_T0_00201
PJMF280N60E1_T0_00201 PJMF600N65E1_T0_00201 PJMF900N65E1_T0_00201